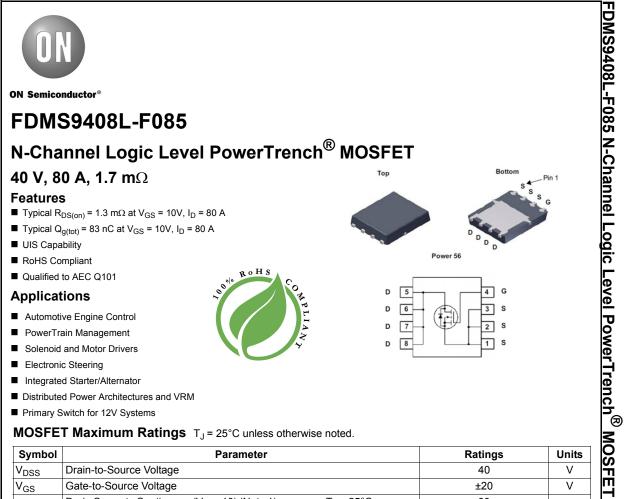
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V _{GS}	Gate-to-Source Voltage		±20	V
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 25°C	80	А
	Pulsed Drain Current	T _C = 25°C	See Figure 4	A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	123	mJ
р	Power Dissipation		214	W
PD	Derate Above 25°C		1.43	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.7	°C/W
R_{\thetaJA}	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W

Notes:

1: Current is limited by bondwire configuration.

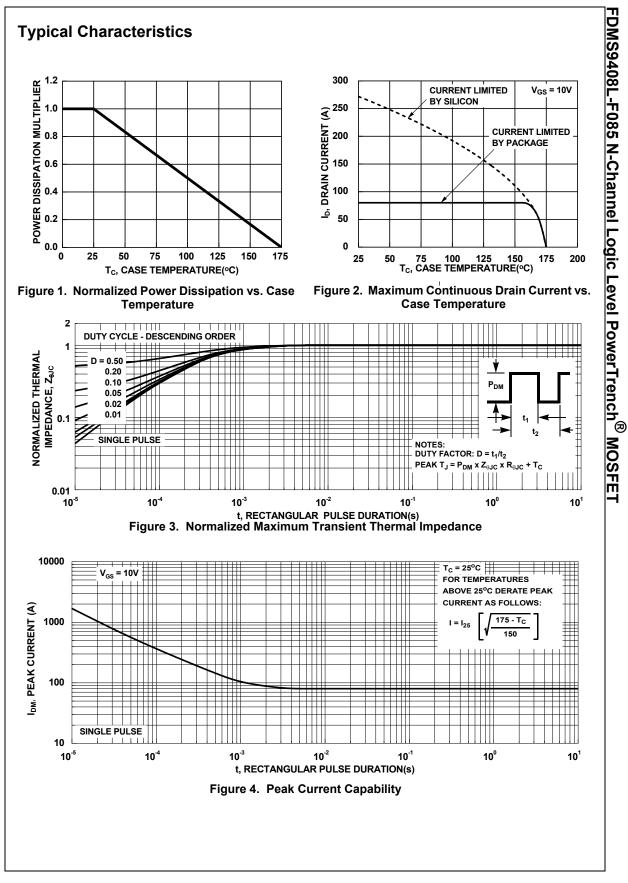
2: Starting $T_J = 25^{\circ}$ C, L = 60uH, $I_{AS} = 64$ A, $V_{DD} = 40$ V during inductor charging and $V_{DD} = 0$ V during time in avalanche.

3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

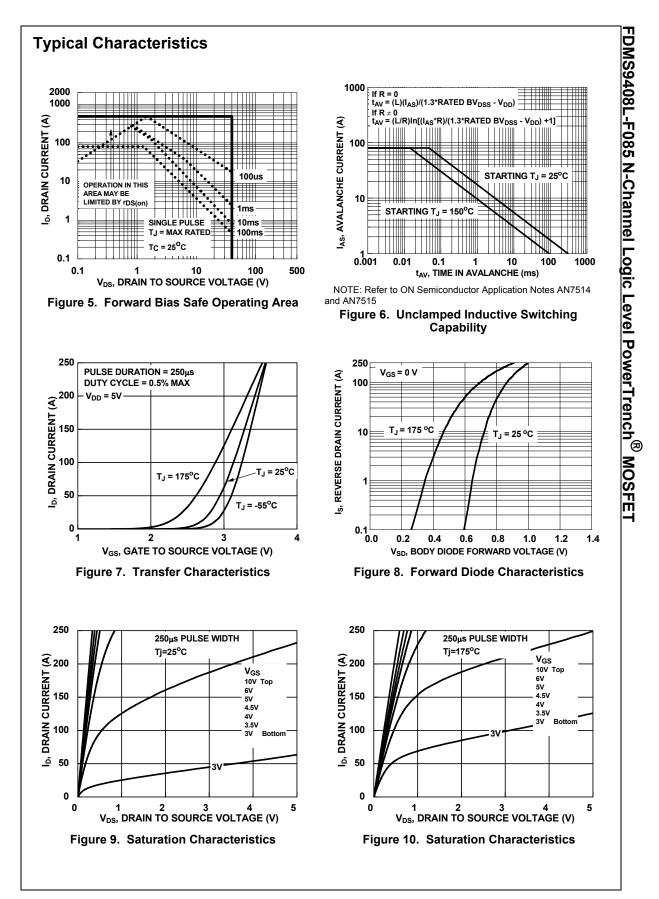
Package Marking and Ordering Information

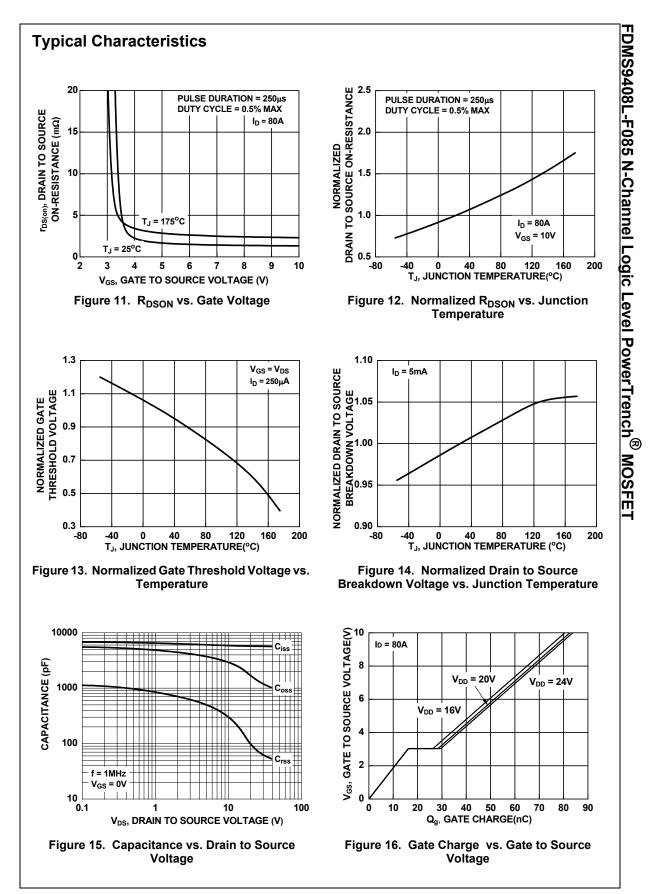
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9408L	FDMS9408L-F085	Power56	13"	12mm	3000units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	aracteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA,	V _{GS} = 0V	40	-	-	V
1	Drain-to-Source Leakage Current	V _{DS} =40V, T _J = 25°C		-	-	1	μA
IDSS	Drain-10-Source Leakage Current	$V_{GS} = 0V$	T _J = 175 ^o C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$		1.0	1.8	3.0	V
		I _D = 80A, V _{GS} = 4.5V		-	1.9	2.5	mΩ
R _{DS(on)}	Drain to Source On Resistance	I _D = 80A,	$T_J = 25^{\circ}C$	-	1.3	1.7	mΩ
		V _{GS} = 10V	T _J = 175 ^o C (Note 4)	-	2.2	2.9	mΩ
•					5750		~ ~
C _{iss}	Input Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$ f = 1MHz		-	5750	-	pF
C _{oss}	Output Capacitance Reverse Transfer Capacitance			-	1730 100	-	pF
C _{rss}	Gate Resistance			-	2.7	-	pF Ω
R _g	Total Gate Charge	f = 1MHz V _{GS} = 0 to 10V V _{DD} = 32V		-	83	- 110	nC
Q _{g(ToT)}	Threshold Gate Charge	$V_{GS} = 0$ to 1 $V_{GS} = 0$ to 2			10	-	nC
Q _{g(th)}	Gate-to-Source Gate Charge	V _{GS} - 0 10 2	1 _D – 60A	_	16	_	nC
Q _{gs} Q _{gd}	Gate-to-Drain "Miller" Charge		-	-	13	-	nC
	ng Characteristics						
t _{on}	Turn-On Time			-	-	40	ns
t _{d(on)}	Turn-On Delay		-	-	14	-	ns
<u>t_r</u>	Rise Time	$V_{DD} = 20V, I_D = 80A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		-	13	-	ns
t _{d(off)}	Turn-Off Delay			-	58	-	ns
t _f	Fall Time			-	26	-	ns
t _{off}	Turn-Off Time			-	-	126	ns
Drain-S	ource Diode Characteristics						
V	Source to Drain Diade Veltage	I _{SD} =80A, V _{GS} = 0V		-	-	1.25	V
V _{SD}	Source-to-Drain Diode Voltage	I _{SD} = 40A, V _{GS} = 0V		-	-	1.2	V
+	Reverse-Recovery Time	I _F = 80A, dI _{SD} /dt = 100A/μs V _{DD} = 32V		-	74	111	ns
t _{rr}					85	128	nC



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